

# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub>	60	٧
Average Rectified Output Current	Io	2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms	I <sub>FSM</sub>	30	Α

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	100	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	$R_{ heta JC}$	31	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-65 to +175	°C

### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

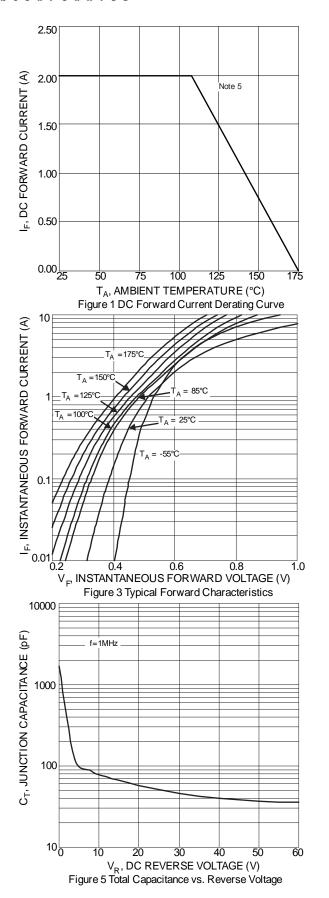
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	-	0.52	0.60	V	I <sub>F</sub> = 1A, T <sub>J</sub> = +25°C
			0.60	0.70		$I_F = 2A, T_J = +25^{\circ}C$
Leakage Current (Note 6)	I <sub>R</sub>	_	0.2	0.8	μA	$V_R = 60V$ , $T_J = +25^{\circ}C$
		1	60	-	μΑ	$V_R = 60V$ , $T_J = +125$ °C

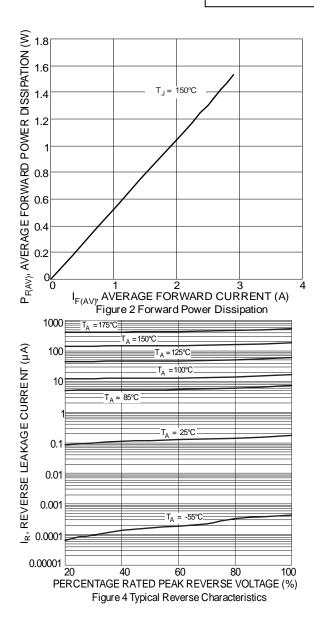
Notes:

 $<sup>5. \ \, \</sup>text{Device mounted on FR-4 substrate, 0.4"*} \\ 0.5\text{", 2oz, single-sided, PC boards with 0.2"*} \\ 0.25\text{" copper pad...} \\$ 

<sup>6.</sup> Short duration pulse test used to minimize self-heating effect.





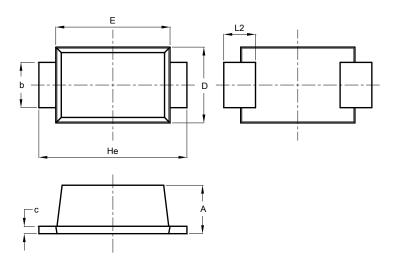




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOD123F

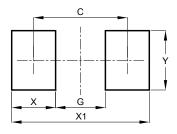


SOD123F				
Dim	Min	Max	Тур	
Α	0.81	1.15	-	
b	0.80	1.35	-	
С	0.05	0.30	-	
D	1.70	1.90	1.80	
Е	2.60	2.80	2.70	
He	3.30	3.70	3.50	
L2	0.35	0.85	-	
All Dimensions in mm				

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOD123F



Dimensions	Value (in mm)
С	2.86
G	1.52
Х	1.34
X1	4.20
Y	1.80



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